

NCE6007S

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE6007S uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

V_{DS} =60V,I_D =7A

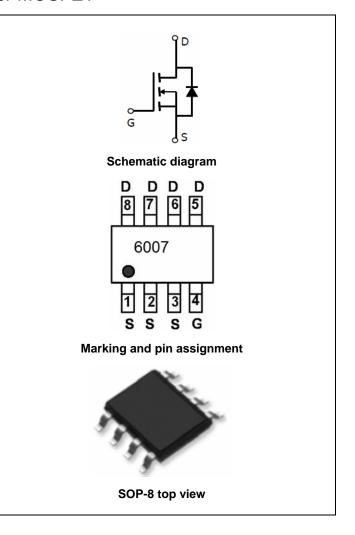
 $R_{DS(ON)} < 30 m\Omega \text{ @ } V_{GS} \text{=} 10 V \qquad (\text{Typ: } 24 m\Omega)$

 $R_{DS(ON)} < 35m\Omega$ @ V_{GS} =4.5V (Typ: 27m Ω)

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Low gate to drain charge to reduce switching losses

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
6007	NCE6007S	SOP-8	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

<u> </u>	<u> </u>		
Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	60	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	7	А
Drain Current-Continuous(T _C =100°C)	I _D (100℃)	5	Α
Pulsed Drain Current	I _{DM}	40	А
Maximum Power Dissipation	P _D	2.1	W
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}$ C

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ hetaJA}$	60	°C/W

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Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	60	69	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V,V _{GS} =0V	_{OS} =60V,V _{GS} =0V		1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS},I_{D}=250\mu A$	1.0	1.4	2.0	V
Danier Course On Otata Basistana	_	V _{GS} =10V, I _D =7A		24	30	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =6A		27	35	mΩ
Forward Transconductance	g FS	V_{DS} =5 V , I_{D} =7 A		20	-	S
Dynamic Characteristics (Note4)	<u> </u>		I.	ı	<u> </u>	
Input Capacitance	C _{lss}	V 05VV 0V		1920		PF
Output Capacitance	Coss	V_{DS} =25V, V_{GS} =0V, F=1.0MHz		155		PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHZ		116		PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	8	-	nS
Turn-on Rise Time	t _r	V_{DS} =30V, R_L =4.7 Ω	-	5	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{GEN} =3 Ω	-	29	-	nS
Turn-Off Fall Time	t _f		-	6	-	nS
Total Gate Charge	Qg	\/ _20\/ _74	-	50	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =30V, I_{D} =7A, V_{GS} =10V	-	8	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	16	-	nC
Drain-Source Diode Characteristic	cs			•	•	
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =7A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	7	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, I _F =7A	-	35	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	43	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD))

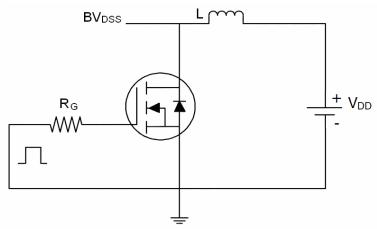
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

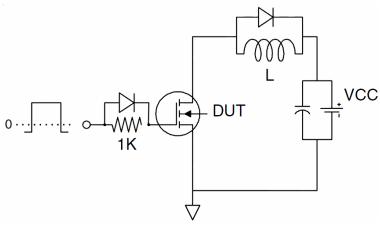


Test Circuit

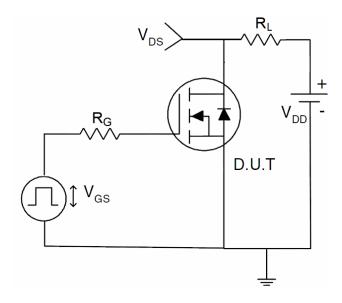
1) E_{AS} test Circuits



2) Gate charge test Circuit

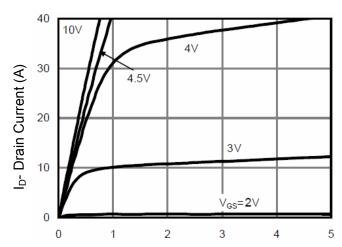


3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V)



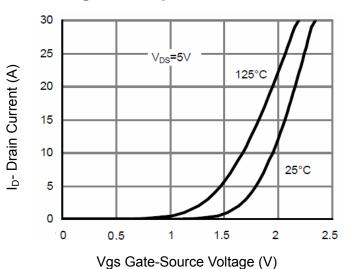


Figure 2 Transfer Characteristics

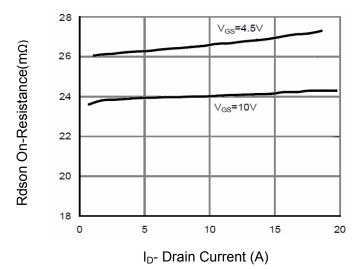


Figure 3 Rdson- Drain Current

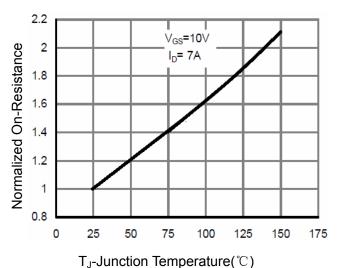


Figure 4 Rdson-JunctionTemperature

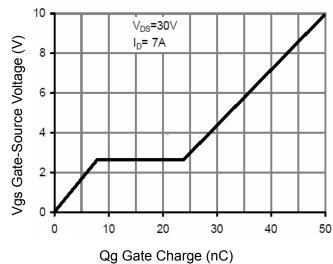


Figure 5 Gate Charge

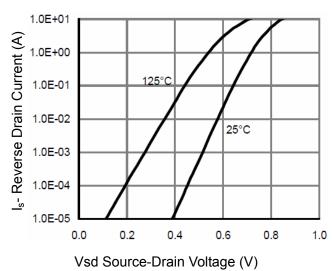


Figure 6 Source- Drain Diode Forward



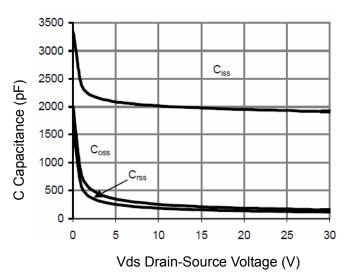


Figure 7 Capacitance vs Vds

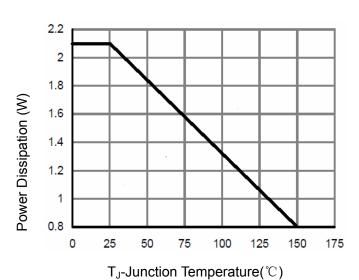


Figure 9 Power De-rating

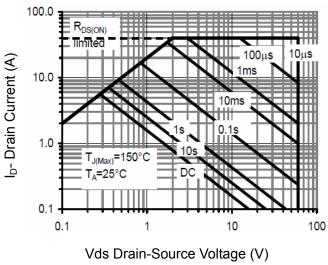


Figure 8 Safe Operation Area

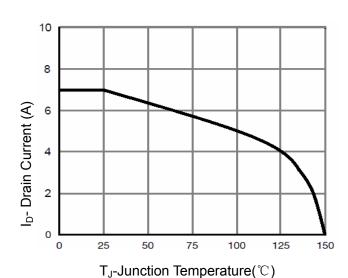


Figure 10 Current De-rating

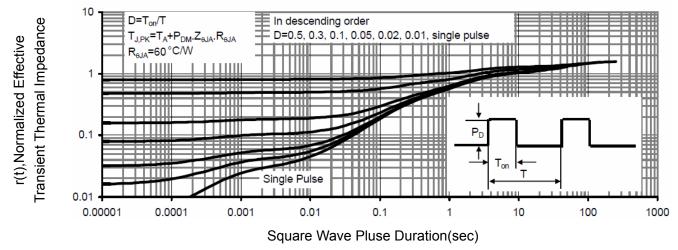


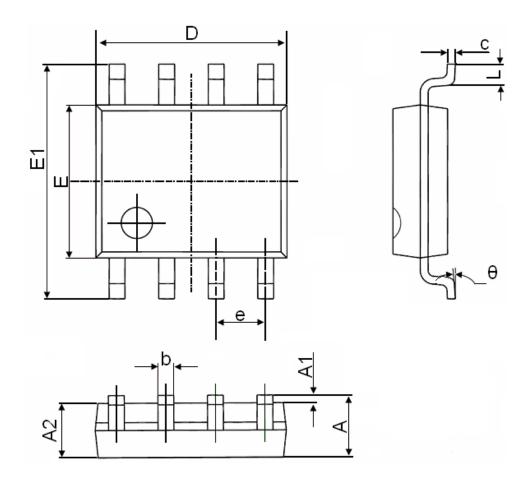
Figure 11 Normalized Maximum Transient Thermal Impedance



NCE6007S

Pb Free Product

SOP-8 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270(BSC)		0.050(BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



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